

HiRel L- and S-Band GaAs General Purpose Amplifier

- HiRel Discrete and Microwave Semiconductor
- Single-stage monolithic microwave IC (MMIC-amplifier)
- Application range: 100 MHz to 3 GHz
- Gain: 9.5 dB typ. @ 1.8 GHz
- Low noise figure: 2.7 dB typ. @ 1.8 GHz
- Bandwidth: 3 GHz typ. @ -3 dB, VSWR < 2 : 1 * Operating voltage range: 3 to 5.5 V
- Input and output matched to 50 Ω
- Individual current control with neg. gate bias
- Hermetically sealed ceramic package micro-x
- ESD: Electrostatic discharge sensitive device, observe handling precautions!



Туре	Marking	Ordering Code	Circuit Diagram	Package
			(Pin Configuration)	
CGY41 (ql)	-	see below	OUT (½) IN (Ve) 1 2,4 (V5)	Micro-X

(ql) Quality Level:	P: Professional Quality,	Ordering Code:	on request
	H: High Rel Quality,	Ordering Code:	on request
	S: Space Quality,	Ordering Code:	on request
	ES: ESA Space Quality,	Ordering Code:	on request

(see order instructions for ordering example)



Maximum ratings	Symbol	Value	Unit
Drain-voltage	V _D	5.5	V
Gate-voltage	$V_{\rm G}$	-4 0	V
Drain-gate voltage	$V_{_{ m DG}}$	9.5	V
RF Input power ¹⁾	$P_{RF_{\rm IN}}$	16	dBm
Channel temperature	$T_{ m Ch}$	175	°C
Storage temperature range	$T_{\rm stg}$	-55+175	°C
Total power dissipation (T _s \leq 82°C) ²⁾	P _{tot}	440	mW
Thermal resistance			
Channel-soldering point ²⁾	$R_{_{ m thChS}}$	155	K/W

Notes: Exceeding any of the max. ratings may cause permanent damage to the device. Appropriate handling is required to protect the electrostatic sensitive MMIC against degradation due to excess voltage or current spikes. Proper ground connection of leads 2 and 4 (with min. inductance) is required to achieve the guaranteed RF performance, stable operating conditions and adequate cooling.

1) @ $V_D > 4.5$ V derating required.

2) Ts is measured on the source lead at the soldering point to the PCB.



Electrical Characteristics

 $T_A = 25 \text{ °C}$, $V_G = 0 \text{ V}$, $V_D = 4.5 \text{ V}$, $R_S = R_L = 50 \Omega$, unless otherwise specified (for application circuit see next page)

Characteristics	Symbol	min	typ	max	Unit
Drain current	I _D	40	60	80	mA
Power gain f = 200 MHz f = 1800 MHz	G	9.5 8.5	10.5 9.5	12 11	dB
Gain flatness f = 200 to 1000 MHz f = 800 to 1800 MHz	ΔG	-	0.4 1.1	- 2	dB
Noise figure f = 200 to 1000 MHz f = 800 to 1800 MHz	F	-	2.5 2.7	- 4.0	dB
Input return loss f = 200 to 1000 MHz f = 800 to 1800 MHz	RL _{IN}	-	13 12	- 9.5	dB
Output return loss f = 200 to 1000 MHz f = 800 to 1800 MHz	RL _{out}	-	12 12	- 9.5	dB
Third order intercept point Two tone intermodulation test $f_1 = 806 \text{ MHz}$, $f_2 = 810 \text{ MHz}$ $P_0 = 10 \text{ dBm}$ (both carriers)	IP3	31	32	-	dBm
1dB gain compression f = 200 to 1800 MHz	P_{1dB}	-	18	-	dBm
Gain control dynamic range, (per gate control voltage) f = 200 to 1000 MHz	ΔG	_	30	_	dB
f = 800 to 1800 MHz		-	20	-	



Application Circuit (f = 800 to 1800 MHz)



Legend of components

C ₁ , C ₂	Chip capacitors 100 pF
C_3 , C_4	Chip capacitors 1 nF
L ₁	For optimized input matching
	- discrete inductor: approx. 3nH, or
	- printed microstripline inductor: Z approx. 100 Ω ,
	l _e approx. 5 mm
L ₂ , L ₃	- discrete inductor: approx. 40 nH, as e.g. 5 turns 0.25 mm copper
	wire on nylon rod with M3-thread, or
	- printed microstripline inductor
D	Z diode 5.6 V (type BZW 22 C5 V 6)

CGY41



Total Power Dissipation $P_{tot} = f(T_S; T_A)$





Order Instructions:

Full type variant including quality level must be specified by the orderer. For *HiRel* Discrete and Microwave Semiconductors the ordering code specifies device family and quality level only.

Ordering Form:

Ordering Code: Q..... CGY41 (ql) (ql): Quality Level

Ordering Example: tbd

Further Informations:

See our WWW-Pages:

- Discrete and RF-Semiconductors (Small Signal Semiconductors)

www.infineon.com/products/discrete/hirel.htm

- *HiRel* Discrete and Microwave Semiconductors www.infineon.com/products/discrete/hirel.htm

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Micro-X Package

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